

Title (en)

WAX MIXTURE BASED ON PARTIAL GLYCERIDES AND PENTAERYTHRIOL ESTERS

Title (de)

WACHMISCHUNG AUF BASIS VON PARTIALGLYCERIDEN UND PENTAERYTHRITESTERN

Title (fr)

MELANGE DE CIRE A BASE DE GLYCERIDES PARTIELS ET D'ESTERS DE PENTAERYTHRITOL

Publication

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Application

**EP 05716400 A 20050326**

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Abstract (en)

[origin: WO2005097056A1] The invention relates to water-free wax mixtures containing, as components, (a) at least one pentaerythriol, dipentaerythriol, tripentaerythriol ester or any particular mixture of said esters and as components (b) at least one partial glyceride, wherein the ratio from (a)- to- (b)- is from 1: 3 to 3: 1. The invention also optionally relates to self-emulsifying bases which contain the inventive wax mixture in addition to at least one emulsifier (c) which is selected from the group of anionic or non-ionic emulsifiers having an HLB value greater than 10. The invention further relates to the use of the wax mixtures or self-emulsifying bases in the cosmetic industry.

IPC 8 full level

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